



P1210XGF1MA	00
V1.4	
2021-10-28	
y Specification	
	V1.4 2021-10-28

Approved by		Notes

TIANMA Confirmed:

Customer:

Prepared by	Checked by	Approved by
Chunhui.Yang	Longping.Deng	

This technical specification is subjected to change without notice







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Record of Revision

Rev	Issued Date	Description	Editor
1.0	2020-09-29	Preliminary Specification Released.	Chunhui.Yang
1.1	2021-1-26	Add LVDS data parameters in Page 11.	Chunhui.Yang
1.2	2021-4-14	Change LED Forward Item in Page 8.	Chunhui.Yang
1.3	2021-10-20	Change LVDS data parameters.	Chunhui.Yang
1.4	2021-10-28	Update LVDS data parameters.	Chunhui. Yang
			,





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General Specifications

	Feature	Spec		
	Size	12.1 inch		
	Resolution	1024(RGB) x 768		
	Technology Type	SFT		
Dianlay Space	Pixel Configuration	R.G.B. Vertical Stripe		
Display Spec.	Pixel Pitch (mm)	0.240 (H) × 0.240 (V)		
	Display Mode	Transmissive, Normally Black		
	Surface Treatment(Up Polarizer)	AG		
	Viewing Direction	All direction		
	LCM (W x H x D) (mm)	260.5x203x9.5		
	Active Area(mm)	245.76*184.32		
Mechanical	With /Without TSP	Without Touch Screen		
Characteristics	Matalian Connection Tons	CN1: FI-S20S		
	Matching Connection Type	CN2: SHLP-10V-S-B		
	Weight (g)	(550g)		
Electrical	Interface	1port LVDS 8bit		
Characteristics	Color Depth	16.7M&262K		

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: +/- 5%





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2 Input/Output Terminals

2.1 TFT LCD Panel (CN1)

Connector type: FI-SEB20P-HFE(JAE)

Matching connector: FI-S20S, FI-SE20-ME(JAE)

Pin No.	Symbol	I/O	Function	Remark
1	Vcc	Р	+3.3V Power supply	
2	Vcc	Р	+3.3V Power supply	
3	GND	Р	Ground	
4	GND	Р	Ground	
5	D0-	I	LVDS Channel 0-	
6	D0+	I	LVDS Channel 0+	
7	GND	Р	Ground	
8	D1-	I	LVDS Channel 1-	
9	D1+	I	LVDS Channel 1+	
10	GND	Р	Ground	
11	D2-	I	LVDS Channel 2-	
12	D2+	I	LVDS Channel 2+	
13	GND	Р	Ground	
14	CLK-	I	LVDS Clock-	
15	CLK+	I	LVDS Clock+	
16	GND	Р	Ground	
17	D3-	I	LVDS Channel3-	
18	D3+	L	LVDS Channel3+	
19	MODE		Low=ISP 6bit compatibility mode	Defalut H
18	IVIODE		High=ISP 8bit compatibility mode	Delaiut H
20	sc		Scan direction control	Defalut L
20	30	1	(High: Normal Low: Reverse)	Defalut H

Note1: I/O definition. I---Input pin, O---Output pin, P--- Power/Ground, N--- No Connection



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2.1 Backing it (ON2)

Connector type: SM10B-SHLS-TF(LF)(SN)(JST) **Matching connector**:SHLP-10V-S-B(JST)

No	Symbol	I/O	Description	Remarks
1	NC	N	This pin should be open	
2	NC	N	This pin should be open	
3	LEDC1	Р	Cathode 1	
4	LEDA1	Р	Anode 1	
5	LEDA2	Р	Anode 2	
6	LEDC2	Р	Cathode 2	
7	LEDC3	Р	Cathode 3	
8	LEDA3	Р	Anode 3	
9	LEDA4	Р	Anode 4	
10	LEDC4	Р	Cathode 4	

I/O definition:

I----Input O----Output P----Power/Ground N—No Connect





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3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

GND=0V

Item	Symbol	MIN	MAX	Unit	Remark
Voltage Input	Vin	-0.50	5.00	V	Note1
Operating Temperature	Тор	-30.0	80.0	$^{\circ}\mathbb{C}$	
Storage Temperature	Tst	-40.0	90.0	$^{\circ}\!\mathbb{C}$	
			≤95	%	Ta≤40°C
			≤85	%	40℃ <ta≤50℃< td=""></ta≤50℃<>
Relative Humidity (Note2)	RH		≤55	%	50℃ <ta≤60℃< td=""></ta≤60℃<>
			≤36	%	60℃ <ta≤70℃< td=""></ta≤70℃<>
			≤24	%	70℃ <ta≤80℃< td=""></ta≤80℃<>
Absolute Humidity	AH		≤70	g/m³	Ta>70℃

Table 3.1 absolute maximum rating

Note1: The parameter is for driver IC (gate driver, source driver) only.

Note2: Ta means the ambient temperature.

It is necessary to limit the relative humidity to the specified temperature range.

Condensation on the module is not allowed.



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4 Electrical Characteristics

4.1 Driving TFT LCD Panel

VCC=3.3V,GND=0V, Ta=25 $^{\circ}\mathrm{C}$

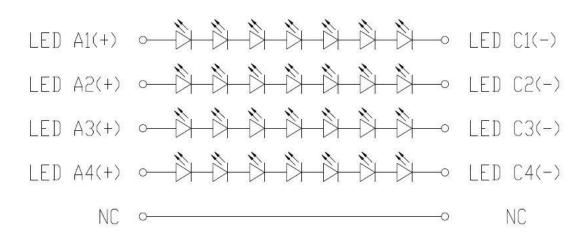
Item		Symbol	MIN	TYP	MAX	Unit	Remark
Power supply	y Voltage	VDD	-	3.3	-	V	
Power supp	ly ripple	Vp-p	-	-	-	mV	
Power suppl	y current	IDD	-	-	-	mA	
LCD power co	nsumption	Р	-	(1200)	-	mW	
Gate On V	/oltage	VGH	-	23	-	V	
Gate On V	Gate On Voltage		-	-7	-	V	
Differential inp	out voltage	Vid	-	-	-	mV	
Power For Ana	alog Circuit	AVDD	-	(12.5)	-	V	
Logic Input Low level		VIL	0	-	0.3VDD	mV	
Voltage High level		ViH	0.7VDD	-	VDD	mV	
Inrush cu	ırrent	Irush	-	-		Α	

4.2 Driving Backlight

Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current Voltage (per string)	V_{F}		21		V	
Forward Current(per string)	I _F	-	115		mA	
Backlight Power Consumption	W_{BL}		9660	-	mW	
LED life time	-	80000	100000		Hrs	

Note 1: The figure below shows the connection of backlight LED.

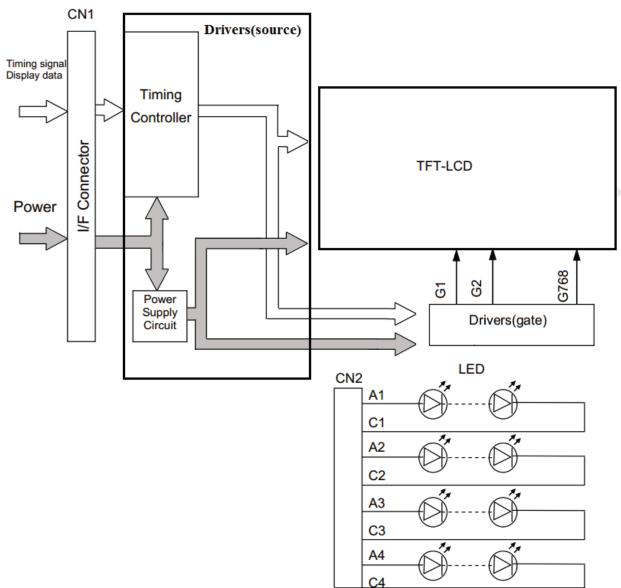






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4.3 Block Diagram



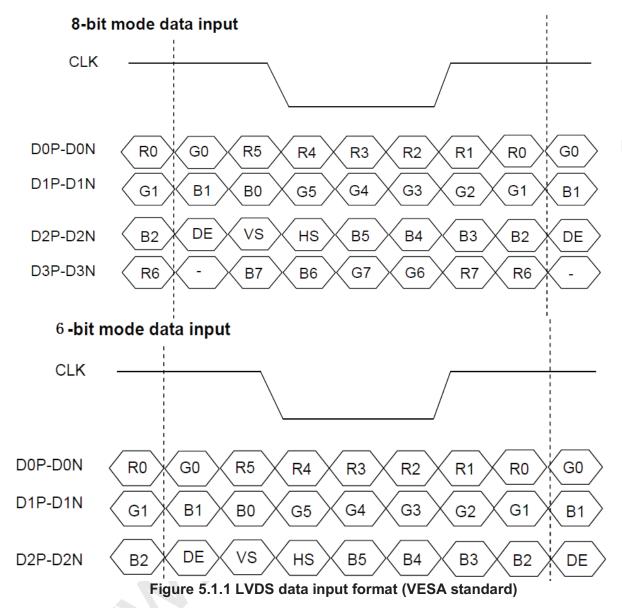




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5 Timing Chart

5.1 LVDS data input format





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DE mode for 1024RGB*768

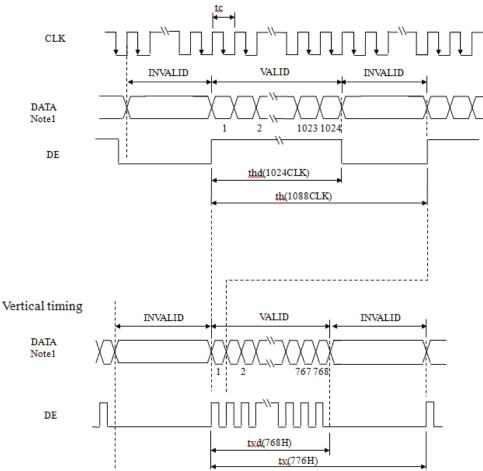


Figure 5.1.2 Recommended input timing of LVDS transmitter

Note1:DATA = R0-R7, G0-G7, B0-B7

Parameter			Symbol	Min.	Тур.	Max.	Unit	Remark								
CLK	Freq	uency	1/tc	50.34	50.66	80	MHz	19.74ns(typ.)								
	Display area		thd		1024		CLK									
Horizontal DE	Period time	th	-	21.477	-	μs	46.561 kHz									
		1 chod time	CI I	1084	1088	1332	CLK	(typ.)								
Vertical (One frame)		Display area	tvd		768		Н									
		Period time	45.4	-	16.666	-	ms	60.0Hz (typ.)								
	(Grio irdino)		renou lime	r enou ume	renou ume	renou ume	renou ume	renou ume	renod time	renou time	renou ume	renod time	tv	774	776	1001

Figure 5.1.3 LVDS data parameters





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6 Optical Characteristics

6.1 Optical Specification

Ta=25°C

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
View Angles		θТ	- CR≧10	80	88	-	- Degree	Note 2
		θВ		80	88	-		
		θL		80	88	-		
		θR		80	88	-		
Contrast Ratio		CR	θ=0°	800	1000	-		Note1 Note3
Response Time		T _{ON} +T _{OFF}	25 ℃	-	25	35	ms	Note1 Note4
Chromaticity	White	х	Backlight is on		TBD		-	Note5 Note1
		У			TBD			
	Red	Х			TBD			
		У			TBD			
	Green	х			TBD			
		У			TBD			
	Blue	х			TBD			
		У			TBD			
Uniformity		U	-	75	80	-	%	Note1 Note6
NTSC		-	0-	65	72	-	%	Note 5
Luminance		L	-	1000	1300	-	cd/m ²	Note1

Test Conditions:

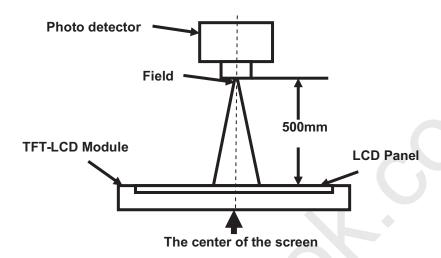
- 2. The test systems refer to Note 1 and Note 2.



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Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system. viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

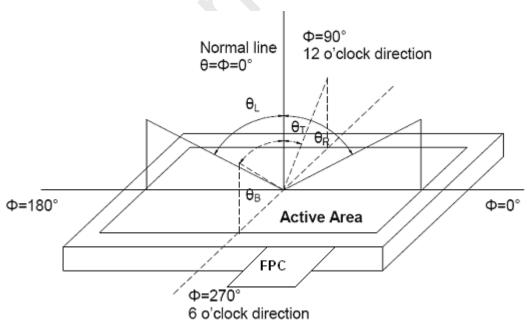


Fig. 1 Definition of viewing angle





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Note 3: Definition of contrast ratio

Luminance measured when LCD is on the "White" state Contrast ratio (CR) = Luminance measured when LCD is on the "Black" state

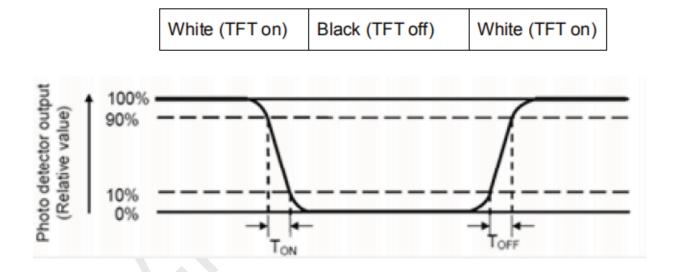
"White state ":The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.



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Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/ Lmax

L-----Active area length W----- Active area width

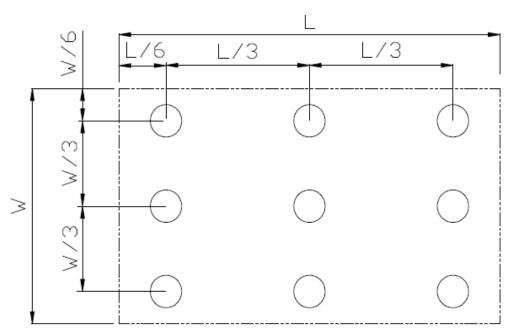


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



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7 Environmental / Reliability Test

No	Test Item	Condition	Remark
1	High Temperature Operation	Ta = +80°C,240 hours	IEC60068-2-1 GB2423.2
2	Low Temperature Operation	Ta = -30℃, 240 hours	IEC60068-2-1 GB2423.1
3	High Temperature Storage	Ta = +90°C, 240 hours	IEC60068-2-1 GB2423.2
4	Low Temperature Storage	Ta = -40℃, 240 hours	IEC60068-2-1 GB2423.1
5	High Temperature & High Humidity Operation	Ta = +60 °C, 90% RH max,240 hours	IEC60068-2-78 GB/T2423.3
6	Thermal Shock (non-operation)	-30°C 30 min~+80°C 30 min, Change time:5min, 100 Cycle	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22
7	ESD	C=150pF,R=330Ω,9point/pan el Air:±15Kv,5times; Contact:±8Kv,5times (Environment:15°C~35°C, 30%~60%.86Kpa~106Kpa)	IEC61000-4-2 GB/T17626.2
8	Vibration Test (Non Op)	5~100HZ,19.60m/s2 1min/cycle 120times Per X\Y\Z	IEC60068-2-6 GB/T17626.6
9	Mechanical Shock (Non Op)	539m/s2, 11ms 5times \pm X、 \pm Y、 \pm Z	IEC60068-2-27 GB/T2423.5

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

Note3: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.

Note 4: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

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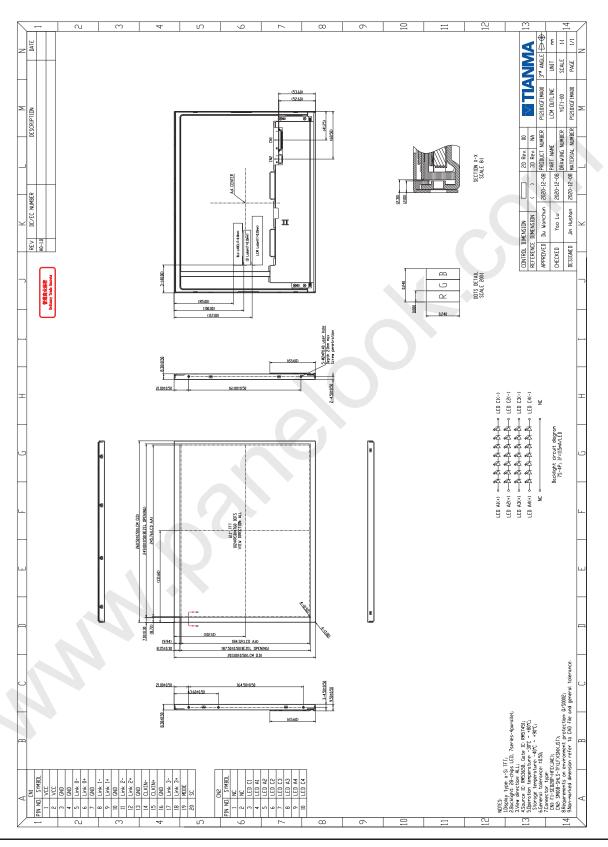
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8 Mechanical Drawing



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9 Packing Drawing

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10 Precautions For Use of LCD Modules

10.1 **Handling Precautions**

- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
- 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 **Storage Precautions**

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

Transportation Precautions 10.3

The

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

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